

1W Power Light LED

LGSV-311E1-1

DATA SHEET

DOC. NO : QW0905-LGSV-311E1-1

REV : A

DATE : 12 - Apr - 2011



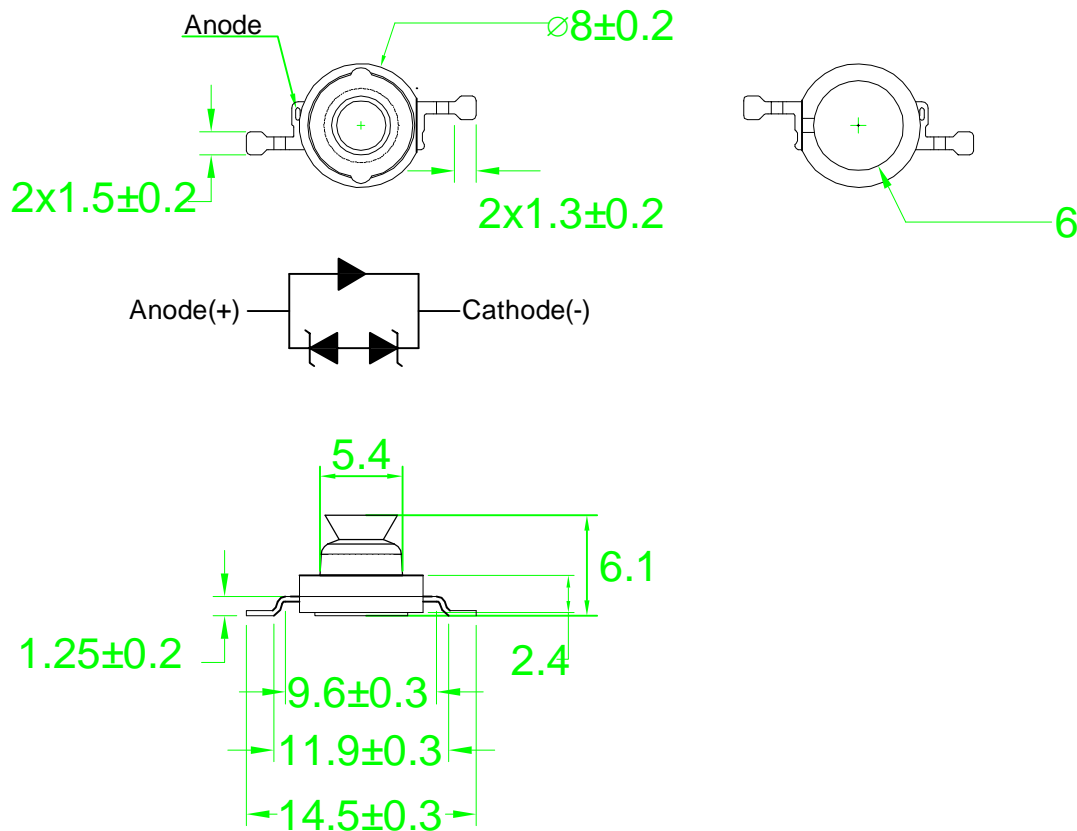
Features

- *. High Flux per LED
- *. Very long operating life(up to 100k hours).
- *. Available in White.
- *. More Energy Efficient than Incandescent and most Halogen lamps.
- *. Low voltage DC operated..
- *. Cool beam, safe to the touch.
- *. Instant light(less than 100 ns).
- *. Fully dimmable.
- *. No UV.
- *. Superior ESD protection..
- *. Soldering methods: hand Soldering.

Typical Applications

- *. Reading Light (car,bus,aircraft)
- *. Portable(flashlight,bicycle).
- *. LCD Backlights / Light Guides.
- *. Automotive Exterior (Stop-Tail-Tum,CHMSL,Mirror Side Repeat).
- *. Commercial and Residential Architectural lighting.
- *. Mini-accent / Uplighters / Downlighters / Orientation lighting
- *. Fiber Optic Alternative / Decorative / Entertainment lighting.
- *. Security / Garden lighting.
- *. Cove / Undershef / Task lighting.
- *. Traffic signaling / Beacons / Rail crossing and Wayside lighting.
- *. Decorative.
- *. Sign and channel Letter.

Dimension



- Note:1. All dimension are in millimeter.
 2. The anode side of the device is denoted by a hole in the lead frame.
 3. The slug has polarity as anode.
 4. It is strongly recommended to apply on electrically isolated heat conducting film between the slug and contact surfaces.
 5. Drawings are not to scale.
 6. All dimensions without tolerances are for reference only.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Ratings	UNIT
		Warm White	
DC Forward Current	IF	350	mA
Power Dissipation	PD	1.4	W
Peak pulse current Duty 1/10@10KHz	IFP	500	mA
LED junction Temperature	Tj	125	°C
Reverse Current(VR=5V)	Ir	100	μA
ESD Sensitivity	VB	±4000	V
Storage Temperature	Tstg	-40 ~ +120	°C
Operating Temperature	Topr	-40 ~ +100	°C
Manual Soldering Time at 260°C(Max)	Tsol	5	seconds

NOTE:

1. Proper current derating must be observed to maintain temperature below the maximum.
2. LEDs are not designed to be driven in reverse bias.

Luminous Flux Characteristics at 350mA (Ratings At 25°C Ambient)

PART NO	Emission Color	Luminous Flux @350mA(Im)			Units
		Min.	Typ.	Max.	Im
LGSV-311E1-1	Warm White	51.7	----	----	

Note :

1. White emitters are built with InGaN.
2. Flux and power is measured with an accuracy of ±10%

. Forward Voltage Characteristics at 350mA

(Ratings At 25°C Ambient)

PART NO	Emission Color	Vf			Units
		Min.	Typ.	Max.	
LGSV-311E1-1	Warm White	3.0	3.6	4.0	V

Note : Forward Voltage is measured with an accuracy of $\pm 0.1V$

. Color Temperature Characteristics at 350mA

(Ratings At 25°C Ambient)

PART NO	Emission Color	CCT			Units
		Min.	Typ.	Max.	
LGSV-311E1-1	Warm White	2670	----	3800	K

Note : CCT $\pm 5\%$ tester tolerance.

. Temperature Coefficient Of Forward Voltage&Thermal Resistance Junction To Board Characteristics at 350mA

(Ratings At 25°C Ambient)

PART NO	Emission Color	$\Delta Vf/\Delta T$		Rth,j-B	
		Typ.	Units	Typ.	Units
LGSV-311E1-1	Warm White	-2	mV/°C	18	°C/W

. Emission Angle Characteristics at 350mA

(Ratings At 25°C Ambient)

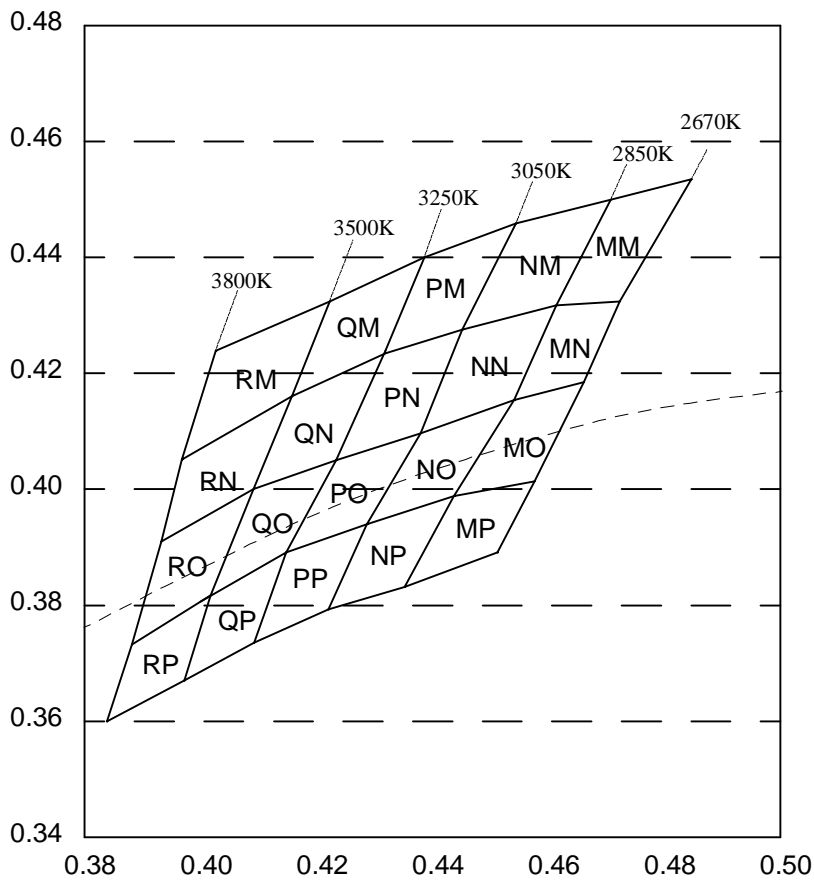
PART NO	Emission Color	Side emitting $\theta_{PEAK}(Typ.)$	Units
LGSV-311E1	Warm White	± 80	Degrees

Brightness Code For High Power LED

Group	Luminous flux(lm)	
	Min	Max
F23	51.7	67.2
F24	67.2	87.4
F25	87.4	113.6

Note : Flux is measured with an accuracy of $\pm 10\%$

White Binning Structure Graphical Representation

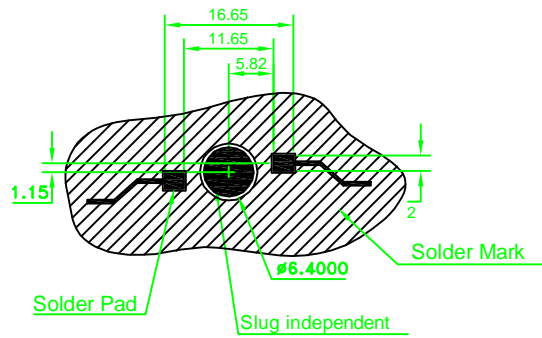


Color Bins
White Bin Structure
20 color bins, CCT range 3800K to 2670K

Bin Code	x	y	Typ. CCT (K)
MO	0.453	0.416	2760
	0.444	0.399	
	0.458	0.403	
	0.467	0.420	
MN	0.461	0.433	2760
	0.453	0.416	
	0.467	0.420	
	0.477	0.437	
MP	0.458	0.403	2760
	0.444	0.399	
	0.436	0.384	
	0.449	0.388	
MM	0.471	0.451	2760
	0.461	0.433	
	0.477	0.437	
	0.487	0.454	
NO	0.438	0.412	2950
	0.429	0.394	
	0.444	0.399	
	0.453	0.416	
NN	0.446	0.429	2950
	0.438	0.412	
	0.453	0.416	
	0.461	0.433	
NP	0.444	0.399	2950
	0.429	0.394	
	0.422	0.379	
	0.436	0.384	
NM	0.454	0.446	2950
	0.446	0.429	
	0.461	0.433	
	0.471	0.451	
PO	0.424	0.406	3150
	0.416	0.389	
	0.429	0.394	
	0.438	0.412	
PN	0.431	0.423	3150
	0.424	0.407	
	0.438	0.412	
	0.446	0.429	
PP	0.429	0.394	3150
	0.416	0.389	
	0.410	0.374	
	0.422	0.379	
PM	0.438	0.440	3150
	0.431	0.423	
	0.446	0.429	
	0.454	0.446	
QO	0.409	0.400	3375
	0.402	0.382	
	0.416	0.389	
	0.424	0.406	
QN	0.415	0.416	3375
	0.409	0.400	
	0.424	0.407	
	0.431	0.423	
QP	0.416	0.389	3375
	0.402	0.382	
	0.397	0.367	
	0.410	0.374	
QM	0.421	0.433	3375
	0.415	0.416	
	0.431	0.423	
	0.438	0.440	
RO	0.392	0.391	3650
	0.387	0.374	
	0.402	0.382	
	0.409	0.400	
RN	0.415	0.416	3650
	0.409	0.400	
	0.392	0.391	
	0.396	0.404	
RP	0.387	0.374	3650
	0.383	0.360	
	0.397	0.367	
	0.402	0.382	
RM	0.421	0.433	3650
	0.415	0.416	
	0.396	0.404	
	0.402	0.423	

NOTE: Tolerance on each color bin(x,y) is ± 0.01

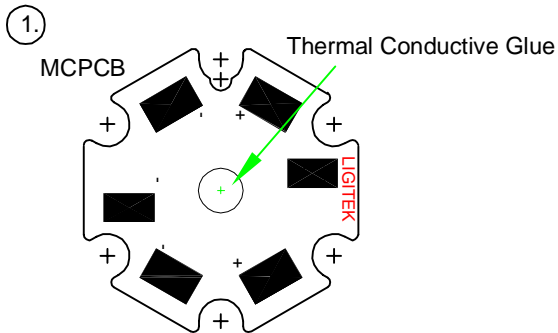
Recommended Solder Pad Design



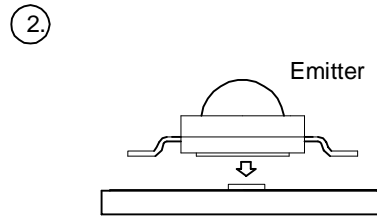
NOTE:

1. All dimensions are in mm.
2. The drawings are not to scale.
3. Solder pad can't be connected to slug.

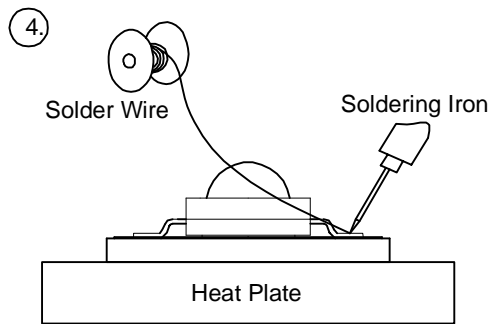
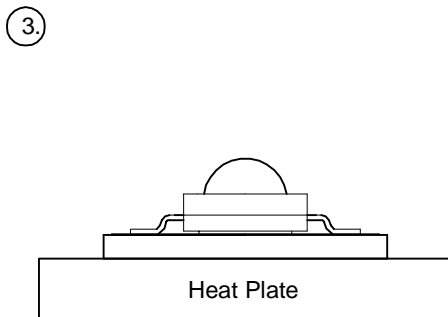
Manual Hand Soldering



Place Thermal Conductive Glue on the MCPCB.



Place Emitter on the MCPCB.



Use Soldering Iron to solder the leads of Emitter within 5 seconds.

- * For prototype builds or small series production runs it possible to place and solder the emitters by hand.
- * Solder tip temperature : 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- * Avoiding damage to the emitter or to the MCPCB dielectric layer.
Damage to the epoxy layer can cause a short circuit in the array.
- * Do not let the solder contact from solder pad to back-side of MCPCB.
This one will cause a short circuit and damage emitter.

Fig.1 Forward current vs. Forward Voltage

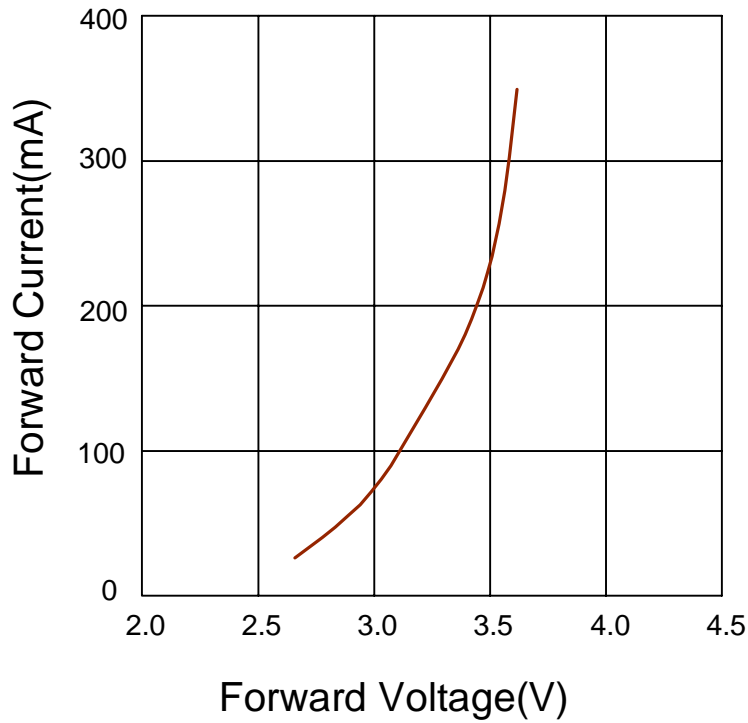


Fig.2 Operating current vs. Ambient Temperature

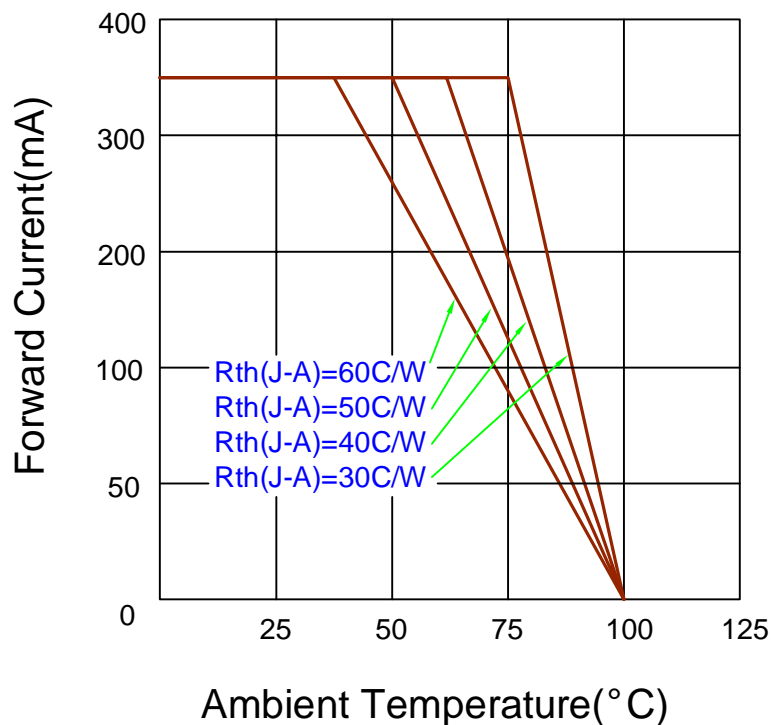


Fig.3 Forward current vs. Luminous Flux

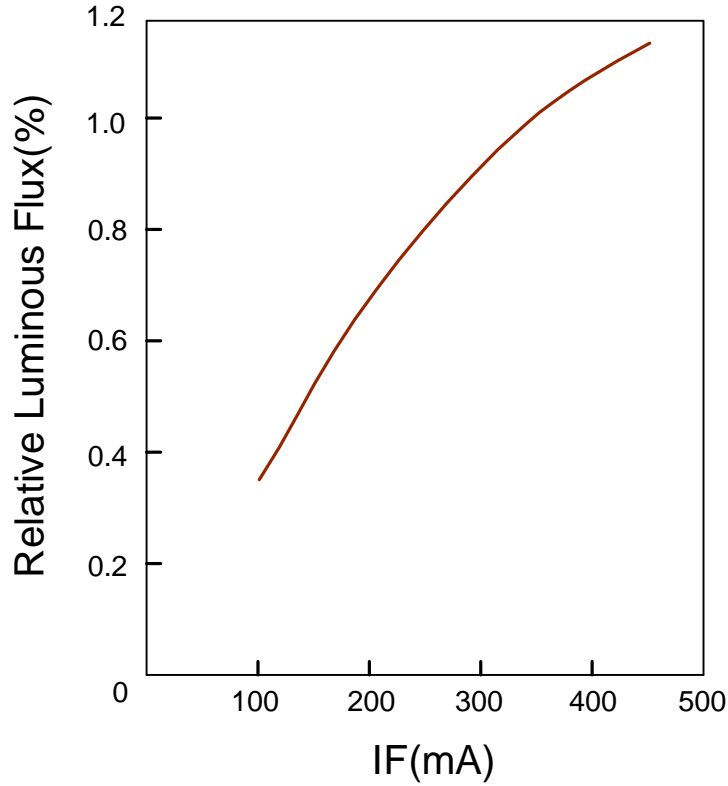


Fig.4 Junction Temperature vs. Forward Voltage

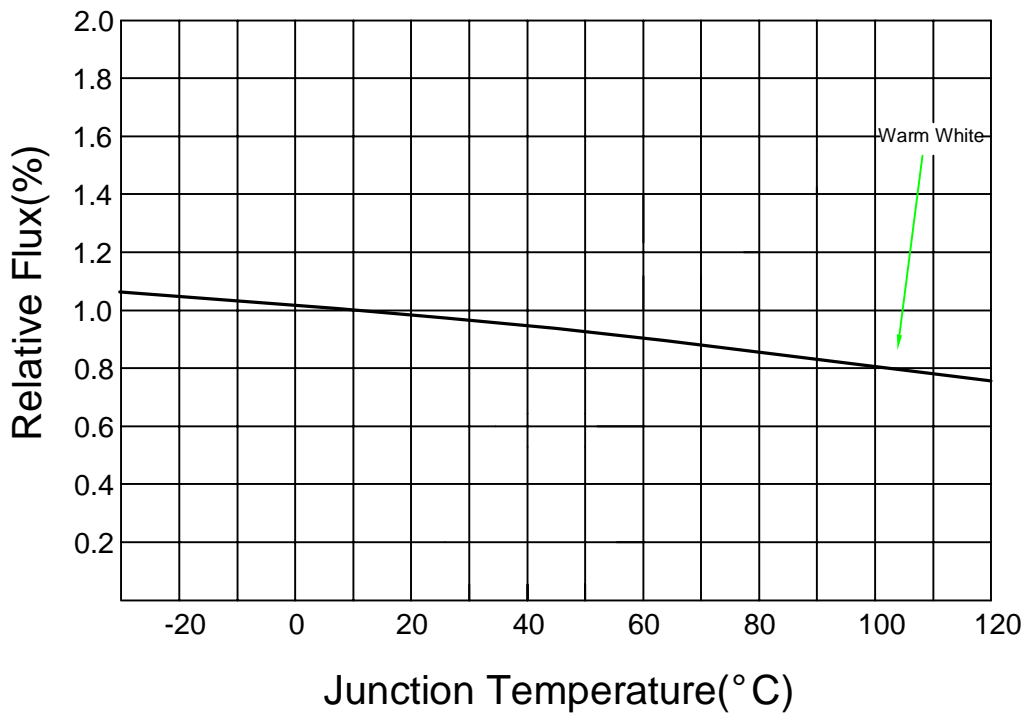


Fig.5 Luminous Spectrum(Ta=25 °C)

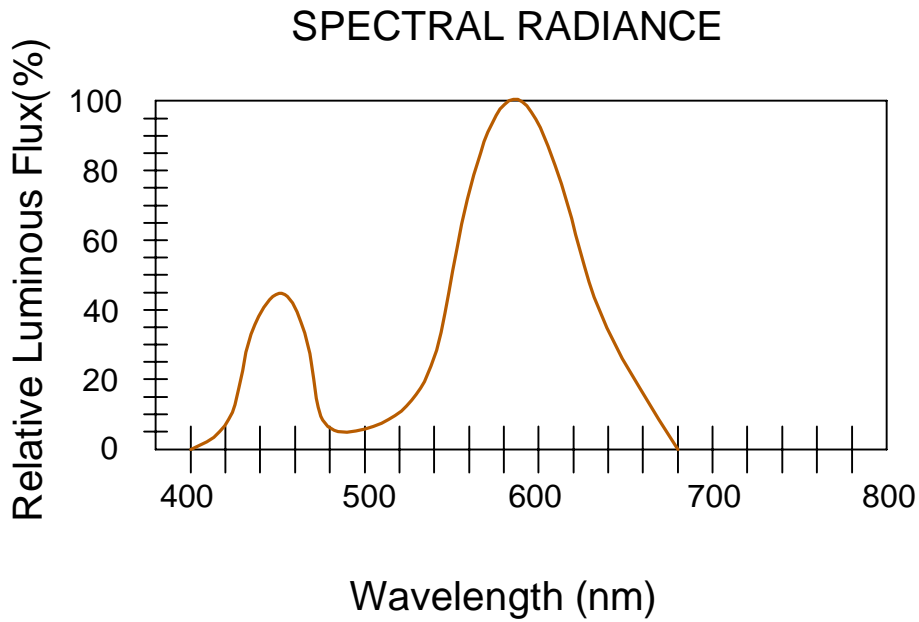
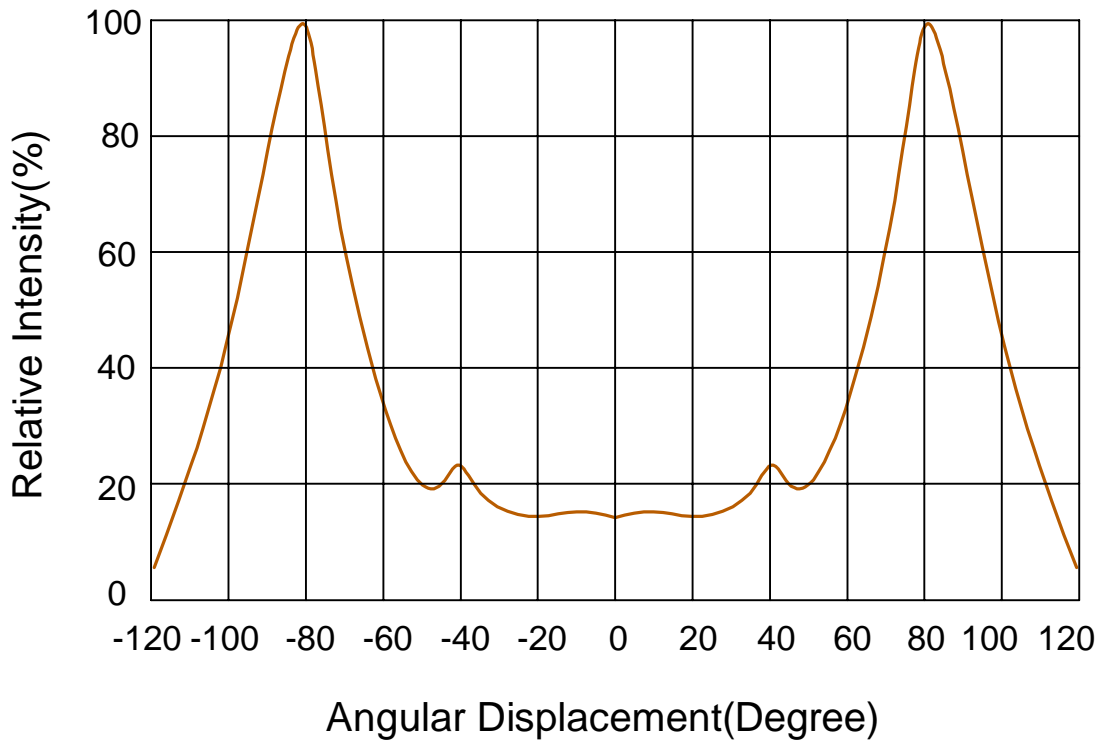
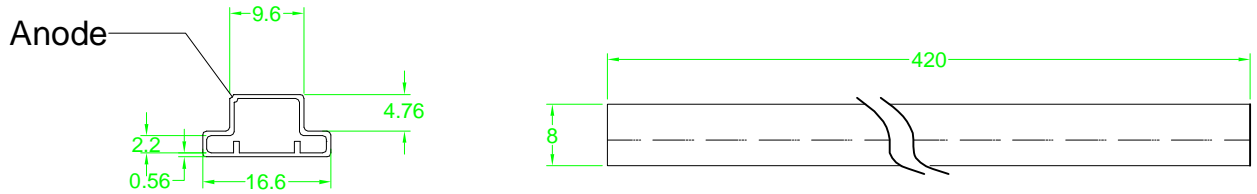


Fig.6 Directivity Radiation



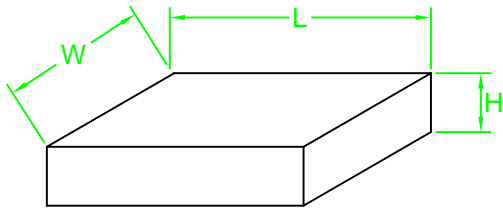
PACKING SPECIFICATION

1. 50PCS / TUBE



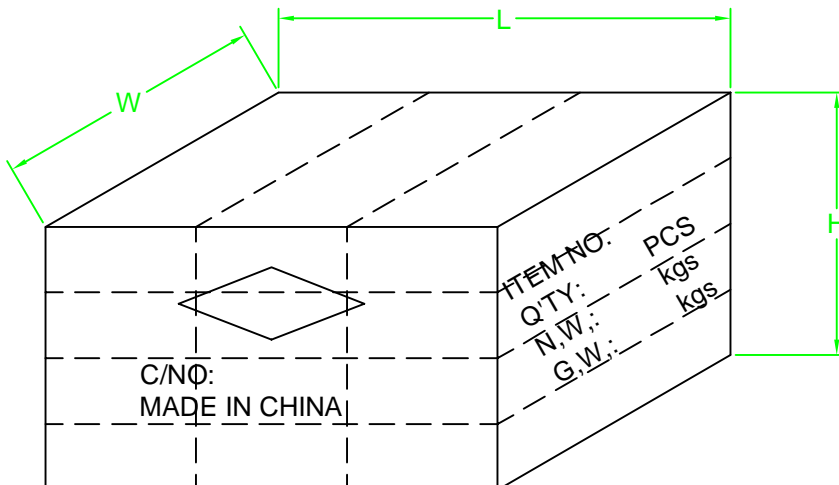
2. 20 TUBES / INNER BOX (10*2)

SIZE : L X W X H 460cm X 110cm X 60cm



3. 10 INNER BOXES / CARTON

SIZE : L X W X H 480cm X 240cm X 325cm



Reliability Test

Item	Description	Stress Condition	Test Duration
RTOL	Room Temperature Operation Life	25° C, Max. IF	1000 hours
WHT	Wet High Temperature	85° C/85%RH	1000 hours
TC	Temperature Cycling	-40/+110° C, 30min dwell,<5min trans.	200 cycles
TS	Thermal Shock	-40/+110° C, 20min dwell,<20min trans.	200 cycles
HTSL	High Temperature Storage Life	120° C	1000 hours
LTSL	Low Temperature Storage Life	-40° C	1000 hours
SHR	Solder Heat Resistance	260±5° C, 5secs	
MS	Mechanical Shock	1500G,0.5msec pulse, 5 shocks each 6 axis	
ND	Natural Drop	On concrete from 1.2m, 3xtimes	
RV	Random Vibration	6G RMS from 10 to 2KHz, 10mins/axis	
VVF	Variable Vibration Frequency	10-2000-10Hz, 20G 1 min, 1.5mm, 3timesx/axis	

Note :

Failure criteria:

Electrical failures

V_F shife $\geq 10\%$

$I_R < 50\mu A @ V_r = 5v$

Ligitek output Degradation

$\%I_v$ shift $\geq 30\% @ 1000hrs$ or 200cycle

Visual failures

Broken or damaged package or lead

Dimension out of tolerance